MBRB4030G, NRVBB4030T4G

Preferred Device

SWITCHMODE Power Rectifier

These state-of-the-art devices use the Schottky Barrier principle with a proprietary barrier metal.

Features

- Guardring for Stress Protection
- Maximum Die Size
- 175°C Operating Junction Temperature
- Short Heat Sink Tab Manufactured Not Sheared
- AEC-Q101 Qualified and PPAP Capable
- NRVBB Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- All Packages are Pb-Free*

Mechanical Characteristics:

- Case: Epoxy, Molded, Epoxy Meets UL 94 V-0
- Weight: 1.7 Grams (Approximately)
- Weight: 1.7 Grams (Approximately)
 Finish: All External Surfaces Corrosion Resistant and Terminal Leads Readily Solderable
 Device Meets MSL1 Requirements
 ESD Ratings:

 Machine Model = C (> 400 V)
 Human Body Model = 3B (> 8000 V)



ON Semiconductor®

http://onsemi.com

SCHOTTKY BARRIER RECTIFIER 40 AMPERES, 30 VOLTS





MARKING DIAGRAM



= Assembly Location

= Year WW = Work Week B4030 = Device Code = Pb-Free Package **AKA** = Diode Polarity

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

Preferred devices are recommended choices for future use and best overall value.

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MBRB4030G, NRVBB4030T4G

MAXIMUM RATINGS

Rating	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	30	V	
Average Rectified Forward Current (At Rated V_R) $T_C = +115^{\circ}C$ (Note 1)	I _{F(AV)}	40	А	
Peak Repetitive Forward Current (At Rated V_R , Square Wave, 20 kHz), $T_C = +112^{\circ}C$	I _{FRM}	80	А	
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	300	А	
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I _{RRM}	2.0	А	
Storage Temperature Range	T _{stg}	-65 to +175	°C	
Operating Junction Temperature Range (Note 2)	TJ	-65 to +175	°C	
Voltage Rate of Change (Rated V _R)	dv/dt	10,000	V/µs	
Reverse Energy (Unclamped Inductive Surge), (T _C = 25°C, L = 3.0 mH)	W	600	mJ	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

- 1. Rating applies when pins 1 and 3 are connected.
- 2. The heat generated must be less than the thermal conductivity from Junction–to–Ambient: $dP_D/dT_J < 1/R_{\theta JA}$.

THERMAL CHARACTERISTICS

Characteristic			Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	. 1	OF	$R_{ heta$ JC	1.0	°C/W
Thermal Resistance, Junction-to-Ambient (Note 3)		SHOW	$R_{\theta JA}$	50	°C/W

^{3.} Rating applies when surface mounted on the miniumum pad size recommended.

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (Notes 4 and 5), per Device ($I_F = 20 \text{ A}$, $T_C = +25^{\circ}\text{C}$) ($I_F = 20 \text{ A}$, $T_C = +150^{\circ}\text{C}$) ($I_F = 40 \text{ A}$, $T_C = +25^{\circ}\text{C}$) ($I_F = 40 \text{ A}$, $T_C = +150^{\circ}\text{C}$)	V _F	0.46 0.34 0.55 0.45	V
Maximum Instantaneous Reverse Current (Note 5), per Device (Rated DC Voltage, $T_C = +25^{\circ}\text{C}$) (Rated DC Voltage, $T_C = +125^{\circ}\text{C}$)	I _R	0.35 150	mA

- 4. Rating applies when pins 1 and 3 are connected.
- 5. Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq 2.0%

ORDERING INFORMATION

Device	Package	Shipping [†]
MBRB4030G	D ² PAK (Pb-Free)	50 Units / Rail
MBRB4030T4G	D ² PAK (Pb-Free)	800 Units / Tape & Reel
NRVBB4030T4G	D ² PAK (Pb-Free)	800 Units / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MBRB4030G, NRVBB4030T4G

ELECTRICAL CHARACTERISTICS

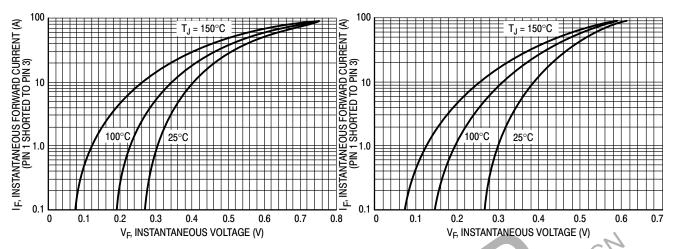


Figure 1. Maximum Forward Voltage

Figure 2. Typical Forward Voltage

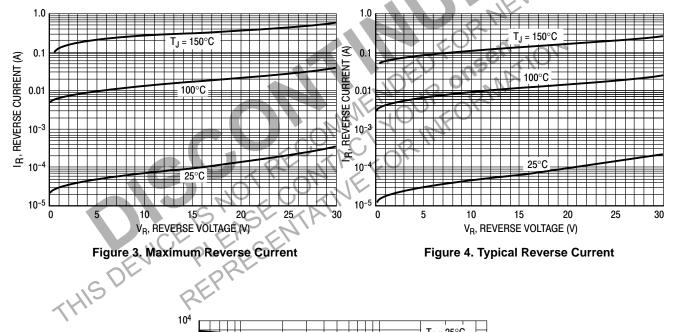


Figure 4. Typical Reverse Current

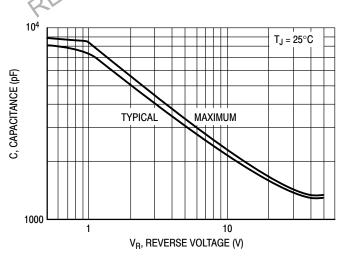


Figure 5. Maximum and Typical Capacitance

MBRB4030G, NRVBB4030T4G

ELECTRICAL CHARACTERISTICS

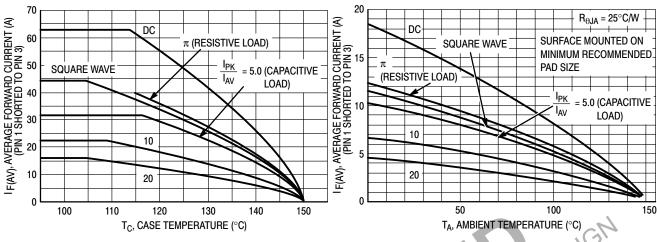


Figure 6. Current Derating, Infinite Heatsink

Figure 7. Current Derating

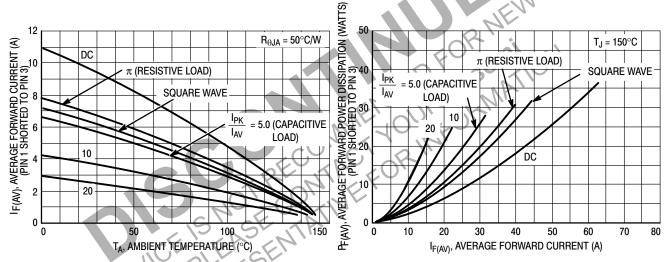


Figure 8. Current Derating, Free Air

Figure 9. Forward Power Dissipation

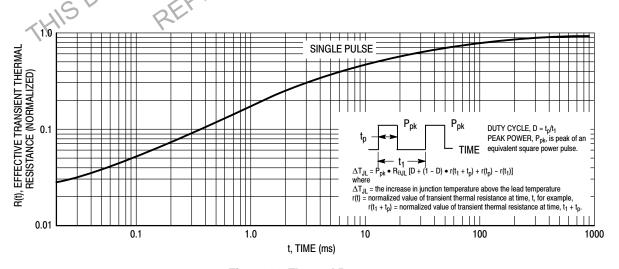


Figure 10. Thermal Response

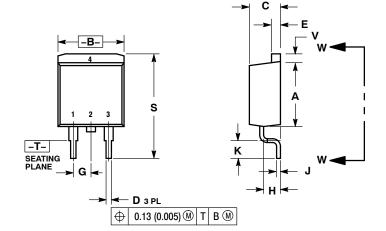




D²PAK 3 CASE 418B-04 **ISSUE L**

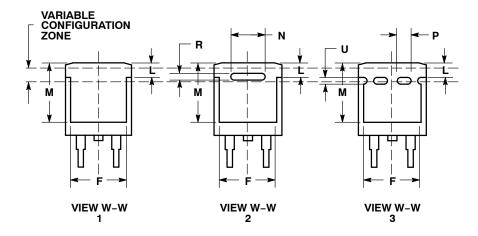
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SCALE 1:1



- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: INCH.
- 3. 418B-01 THRU 418B-03 OBSOLETE,
- NEW STANDARD 418B-04.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.340	0.380	8.64	9.65
В	0.380	0.405	9.65	10.29
C	0.160	0.190	4.06	4.83
D	0.020	0.035	0.51	0.89
E	0.045	0.055	1.14	1.40
F	0.310	0.350	7.87	8.89
G	0.100 BSC		2.54 BSC	
Н	0.080	0.110	2.03	2.79
J	0.018	0.025	0.46	0.64
K	0.090	0.110	2.29	2.79
L	0.052	0.072	1.32	1.83
М	0.280	0.320	7.11	8.13
N	0.197 REF		5.00 REF	
P	0.079 REF		2.00 REF	
R	0.039 REF		0.99 REF	
S	0.575	0.625	14.60	15.88
V	0.045	0.055	1.14	1.40



STYLE 1: PIN 1. BASE 2. COLLECTOR
3. EMITTER
4. COLLECTOR STYLE 2: PIN 1. GATE 2. DRAIN 3. SOURCE 4. DRAIN STYLE 3: PIN 1. ANODE 2. CATHODE 3. ANODE 4. CATHODE

STYLE 4:

PIN 1. GATE 2. COLLECTOR 3. EMITTER 4. COLLECTOR

STYLE 5: PIN 1. CATHODE 2. ANODE 3. CATHODE 4. ANODE

STYLE 6: PIN 1. NO CONNECT 2. CATHODE 3. ANODE 4. CATHODE

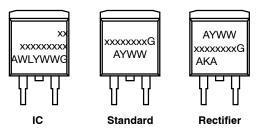
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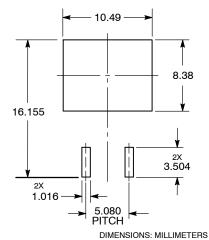
GENERIC MARKING DIAGRAM*



xx = Specific Device Code A = Assembly Location

WL = Wafer Lot
Y = Year
WW = Work Week
G = Pb-Free Package
AKA = Polarity Indicator

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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^{*}This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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